

ORDERING INFORMATION

| Part Number | Top Mark | Operating Temperature Range | Package | Packing Method [†] |
|-------------|----------|--------------------------------|--|-----------------------------|
| FUSB301A | NX | 40 to 85°C | 12 Lead Ultra thin Molded Leadless Package (TMLP) 1.6 mm × 1.6 mm × 0.375 mm | Tape and Reel |

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

BLOCK DIAGRAM

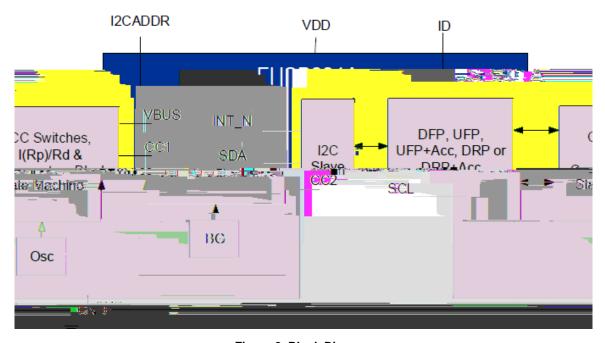


Figure 2. Block Diagram

PIN CONFIGURATION

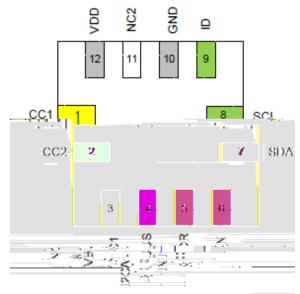


Figure 3. Pin Assignment (Top Through View)

ABSOLUTE MAXIMUM RATINGS (continued)

| Symbol | Parameter | | | Min. | Max. | Unit |
|--------|--|---|--|------|------|------|
| TJ | Maximum Junction Temperature | | | | +150 | °C |
| TL | Lead Temperature (Soldering, 10 seconds) | | | | +260 | °C |
| ESD | IEC 6100 4 2 System ESD | Connector Pins (VBUS, CC1 and CC2) Contact Connector Pins (VBUS, CC1 and CC2) Others All Pins | | 15 | | kV |
| | | | | 8 | | |
| | Human Body Model, JEDEC JESD22 A114 | | | 4 | | |
| | | | | 2 | | |
| | Charged Device Model, JEDEC LESD22 C101 | | | 1 | | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERAING CONDITIONS

| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|------------------|-----------------------|---------|------|------|------|
| V _{BUS} | VBUS Supply Voltage | 3.7 | 5.0 | 21 | V |
| V _{DD} | Supply Voltage | 2.8 (1) | 3.3 | 5.5 | V |
| T _A | Operating Temperature | 40 | | +85 | °C |

^{1.} This is for functional operation only and isn't the lowest limit for all subsequent electrical specifications below. All electrical parameters have a minimum of 3 V operation.

DC AND TRANSIENT CHARACTERISTICS

Unless otherwise specified: Recommended T_A and T_J temperature ranges. All typical values are at $T_A = 25$ °C and $V_{DD} = 3.3$ V unless otherwise specified.

| | | T _A | | | |
|----------------------|--|----------------|------|------|------|
| Symbol | Parameter | Min. | Тур. | Max. | Unit |
| Type C Specific | Parameters | • | 1 | • | • |
| I _{80_CCX} | Source 80 μA CC Current (Default) HOST_CUR1 = 0, HOST_CUR0 = 1 | 64 | 80 | 96 | μА |
| I _{180_CCX} | Source 180 μA CC Current (1.5 A) HOST_CUR1 = 1, HOST_CUR0 = 0 | | 180 | 194 | μΑ |
| I _{330_CCX} | Source 330 μA CC Current (3 A) HOST_CUR1 = 1, HOST_CUR0 = 1 | | 330 | 356 | μΑ |
| V_{SNKDB} | Sink Pull Down Voltage in Dead Battery Under all Pull up SOURCE Loads | | | 2.18 | V |
| R _{DEVICE} | R _{DEVICE} Sink Pull Down Resistance when V _{DD} is within Operating Range | | 5.1 | 5.6 | kΩ |
| zOPEN | CC Resistance for Disabled State | 126 | | | kΩ |
| vRa SRCdef | Ra Detection Threshold for CC Pin for Source for Default Current on VBUS | 0.15 | 0.20 | 0.25 | V |
| vRa SRC1.5A | Ra Detection Threshold for CC Pin for Source for 1.5 A Current on VBUS | 0.35 | 0.40 | 0.45 | V |
| vRa SRC3A | Ra Detection Threshold for CC Pin for Source for 3 A Current on VBUS | | 0.80 | 0.85 | V |
| vRd SRCdef | Rd SRCdef Rd Detection Threshold for Source for Default Current (HOST_CUR1/0 = 01) | | 1.60 | 1.65 | V |
| vRd SRC1.5A | Rd Detection Threshold for Source for 1.5 A Current (HOST_CUR1/0 = 10) | 1.50 | 1.60 | 1.65 | V |

DC AND TRANSIENT CHARACTERISTICS

Unless otherwise specified: Recommended T_A and T_J temperature ranges. All typical values are at $T_A = 25$ °C and $V_{DD} = 3.3$ V unless otherwise specified. (continued)

| | | $T_A = -40 \text{ to } +85^{\circ}\text{C}$ $T_J = -40 \text{ to } +125^{\circ}\text{C}$ | | | |
|-----------|--|---|------|------|------|
| Symbol | Parameter | Min. | Тур. | Max. | Unit |
| vRd SRC3A | Rd Detection Threshold for Source for 3 A Current (HOST_CUR1/0 = 11) | 2.45 | 2.60 | 2.75 | V |
| vRa SNK | Ra Detection Threshold for CC Pin for Sink | 0.15 | 0.20 | 0.25 | V |
| vRd def | Rd Default Current Detection Threshold for Sink | 0.61 | 0.66 | 0.70 | V |
| vRd 1.5A | Rd 1.5 A Current Detection Threshold for Sink | 1.16 | 1.23 | 1.31 | V |
| vRd 3.0A | Rd 3 A Current Detection Threshold for Sink | 2.04 2.11 2.18 | | V | |
| vVBUSthr | VBUS Threshold at which I_VBUSOK Interrupt is Triggered | 3.7 | | V | |

CURRENT CONSUMPTION

| | | | | | = -40 to +8 -40 to +1 | | Unit |
|----------|--|---------------------|---------------------------------------|------|--------------------------|------|------|
| Symbol | Parameter | V _{DD} (V) | Conditions | Min. | Тур. | Max. | Unit |
| Idisable | Disabled Current | 3.0 to 5.5 | Disabled State | | 0.35 | 2.0 | μΑ |
| Istby | Unattached Sink | 3.0 to 5.5 | Nothing attached | | 3.5 | 7.0 | μΑ |
| | Unattached Sink + Acc, Source + Acc, or DRP | | Nothing attached, Internally Toggling | | 5 | 20 | μΑ |
| lattach | Attach Current (Less Host | 3.0 to 5.5 | Attached as a Sink | | 5 | 15 | μΑ |
| | Current) | | Attached as a Source | | 10 | 15 | μΑ |

TIMING PARAMETERS

| | | | $T_A = -40 \text{ to } +85^{\circ}\text{C}$ $T_J = -40 \text{ to } +125^{\circ}\text{C}$ | | | |
|----------------|---|------|---|------|------|--|
| Symbol | Parameter | Min. | Тур. | Max. | Unit | |
| tCCDebounce | Debounce Time for CC (Source or Accessory) | 100 | 150 | 200 | ms | |
| | Debounce Time for CC (Sink) | 63 | 75 | 87 | ms | |
| tPDDebounce | Debounce Time for CC Detach Detection | 10 | 15 | 20 | ms | |
| tAccDetect | Debounce Time to Detect AudioAccessory, or DebugAccessory is Attached | 50 | 100 | 200 | ms | |
| tErrorRecovery | Time staying in the ErrorRecovery State if sent there via the ERROR_REC bit or by a change of Modes | 25 | 50 | 100 | ms | |
| tVBUSondeh | <u> </u> | | Į. | Į. | Ų. | |

TIMING PARAMETERS

| | | | $T_A = -40 \text{ to } +85^{\circ}\text{C}$ $T_J = -40 \text{ to } +125^{\circ}\text{C}$ | | | Unit |
|-------------|---|----------------|---|------|------|------|
| Symbol | Parameter | | Min. | Тур. | Max. | Unit |
| tDRPToggle2 | For DRP Operation, Time Spent in Unat- | DRPROGGLE = 00 | 15 | | 30 | ms |
| | tached.Source before going to Unattached.Sink State | DRPROGGLE = 01 | 20 | | 40 | |
| | | | 25 | | 50 | |
| | | DRPROGGLE = 11 | 30 | | 60 | |

IO SPECIFICATIONS

| | | V _{DD} (V) | Conditions | $T_A = -40 \text{ to } +85^{\circ}\text{C}$ $T_J = -40 \text{ to } +125^{\circ}\text{C}$ | | | Unit |
|-------------------------------|---|---------------------|--------------------------------|---|------|--------------------|------|
| Symbol | Parameter | | | Min. | Тур. | Max. | Unit |
| Host Interface | Pins (ID) | • | | • | | • | |
| V _{OLID} | Output Low Voltage | 3.0 to 5.5 | I _{OL} = 4 mA | | | 0.4 | V |
| Host Interface | Pins (I2CADDR) | • | | • | | • | |
| V _{ILADDR} | Low Level Input Voltage | 3.0 to 5.5 | | | | 0.3V _{DD} | V |
| V _{IHADDR} | High Level Input Voltage | 3.0 to 5.5 | | 0.7V _{DD} | | | V |
| Host Interface | Pins (INT_N) | | | • | | | |
| V _{OLINTN} | Output Low Voltage | 3.0 to 5.5 | I _{OL} = 4 mA | | | 0.4 | V |
| I ² C Interface Pi | ns - Fast Mode SDA, SCL | | | • | | | |
| V _{ILI2C} | Low Level Input Voltage | 3.0 to 5.5 | | | | 0.4 | V |
| V _{IHI2C} | High Level Input Voltage | 3.0 to 5.5 | | 1.2 | | | V |
| V _{HYS} | Hysteresis of Schmitt Trigger Inputs | 3.0 to 5.5 | | 0.2 | | | V |
| I _{I2C} | Input Current of SDA and SCL Pins | 3.0 to 5.5 | Input Voltage 0.26 V to 2 V | 10 | | 10 | μΑ |
| Іссті2С | VDD Current when SDA and SCL are HIGH | 3.0 to 5.5 | Input Voltage 1.8 V | | | 10 | μА |
| V _{OLSDA} | Low Level Output Voltage at 3 mA Sink Current (Open Drain) | 3.0 to 5.5 | | 0 | | 0.3 | V |
| Cı | Capacitance for Each I/O Pin (2) | 3.0 to 5.5 | | | | 10 | pF |

Table 9. MASK (continued)

Address: 10h

Reset Value: 0×XXXX_0000

Type: Read/Write

| Bit # | Name | Size (Bits) | Description |
|-------|----------|-------------|--|
| 2 | M_BC_LVL | 1 | 1: Mask a change in I_BC_LVL interrupt bit |
| 1 | M_DETACH | 1 | 1: Mask the I_DETACH interrupt bit |
| 0 | M_ATTACH | 1 | 1: Mask a change in the I_ATTACH interrupt bit |

Table 10. STATUS

Address: 11h

Reset Value: 0×XX00_0000

Type: Read

| Bit # | Name | Size (Bits) | Description |
|-------|-------------|-------------|---|
| 7:6 | Reserved | 2 | Do Not Use |
| 5:4 | ORIENT[1:0] | 2 | Status to indicate which CCx pins has the CC cable connection 11: A fault has occurred during the detection 10: Cable CC is connected through the CC2 pin 01: Cable CC is connected through the CC1 pin 00: No or unresolved connection detected. |
| 3 | VBUSOK | 1 | 1: Status to indicate VBUS is in the valid range |
| 2:1 | BC_LVL[1:0] | 2 | Thresholds that allow detection of current advertisement on CC line 00: Ra or unattached Sink 01: Rd threshold for Sink default current advertisement 10: RD threshold for Sink 1.5 A current advertisement 11: RD threshold for Sink 3 A current advertisement |
| 0 | ATTACH | 1 | 1: Attached to a device or accessory of a type shown in the Type register |

Table 11. TYPE

Address: 12h

Reset Value: 0×XXX0_0X00

Type: Read

| Bit # | Name | Size (Bits) | Description |
|-------|----------|-------------|--|
| 7:5 | Reserved | 3 | Do Not Use |
| 4 | Sink | 1 | 1: Indicates a Sink has been detected |
| 3 | Source | 1 | 1: Indicates a Source has been detected |
| 2 | Reserved | 1 | Do Not Use |
| 1 | DEBUGACC | 1 | 1: Indicates a Debug Accessory has been detected |
| 0 | AUDIOACC | 1 | 1: Indicates a Audio Accessory has been detected |

Table 12. INTERRUPT0

Address: 13h

Reset Value: 0×XXXX_X000

Type: Write/Clear

| Bit # | Name | Size (Bits) | Description |
|-------|----------|-------------|-------------|
| 7:4 | Reserved | 4 | Do Not Use |
| 3 | I_ACC_CH | 1 | |

Table 12. INTERRUPT0 (continued)

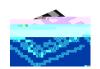
Address: 13h

Reset Value: 0×XXXX_X000

Type: Write/Clear

| Bit # | Name | Size (Bits) | Description |
|-------|----------|-------------|---|
| 1 | I_DETACH | 1 | 1: Interrupt flagged when a device or accessory has been detached |
| 0 | I_ATTACH | 1 | Interrupt flagged when a device or accessory of type indicated in the Type register has been attached |

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X2QFN12 1.60x1.60x0.37, 0.40P CASE 722AD ISSUE A

NOTES:

1.

DATE 15 NOV 2023

